

16A GLASS PASSIVATED SUPERFAST RECTIFIER

Features

- Fred Chip Planar Construction
- Superfast 35nS and 50nS Recovery Time
- Low Forward Voltage Drop
- Low Reverse Leakage Current
- Soft Recovery Characteristics
- Epoxy Meets UL 94V-0 Classification
- Ideally Suited for Use in High Frequency SMPS, Inverters and As Free Wheeling Diodes

Mechanical Data

Case: TO-220A, Molded Plastic

Terminals: Plated Leads Solderable per

MIL-STD-202, Method 208

Polarity: See Diagram

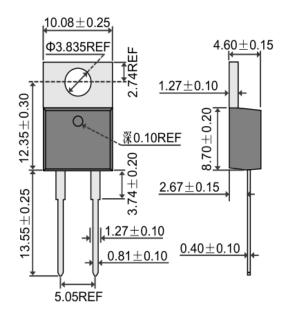
Weight: 1.9 grams (approx.)

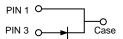
Mounting Position: Any

Mounting Torque: 0.6 N.m Max.

Lead Free: For RoHS / Lead Free Version

TO-220AC





Maximum Ratings and Electrical Characteristics @TA=25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Characteristic | Symbol | MUR 1600 | MUR 1610 | MUR 1615 | MUR 1620 | MUR 1630 | MUR 1640 | MUR 1660 | Unit |
|---|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | VRRM VRWM VR | 50 | 100 | 150 | 200 | 300 | 400 | 600 | V |
| RMS Reverse Voltage | VR(RMS) | 35 | 70 | 105 | 140 | 210 | 280 | 420 | V |
| Average Rectified Output Current @T _C = 100°C | lo | 16 | | | Α | | | | |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method) | IFSM | 250 | | | А | | | | |
| Forward Voltage @I _F = 16A | VFM | 0.975 1.3 | | | 1.5 | V | | | |
| | IRM | 10 500 | | | | μΑ | | | |
| Reverse Recovery Time (Note 1) | trr | | 35 50 | | | nS | | | |
| Typical Junction Capacitance (Note 2) | Cı | 175 145 | | | 145 | pF | | | |
| Thermal Resistance Junction to Ambient Thermal Resistance Junction to Case | R JA R JC | 73 1.2 | | | °C/W | | | | |
| Operating and Storage Temperature Range | TJ, TSTG | -65 to +175 | | | | | | °C | |

Note: 1. Measured with I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A. 2. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.



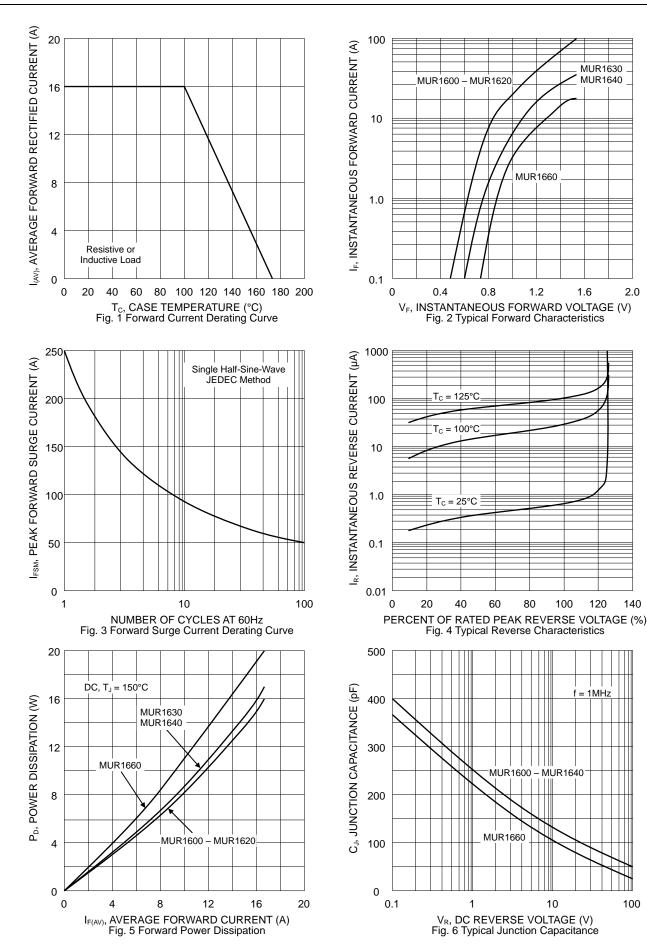
MUR1630

2.0

140

120

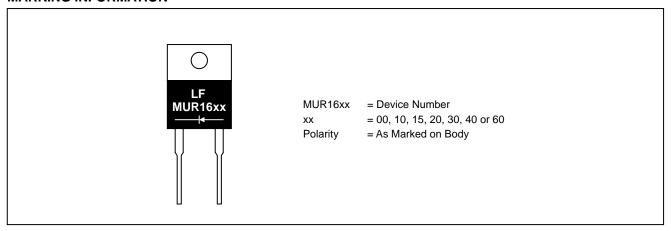




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MARKING INFORMATION



PACKAGING INFORMATION

BULK

| Tube Size L x W x H (mm) | Quantity (PCS) | Inner Box Size L x W x H (mm) | Quantity (PCS) | Carton Size L x W x H (mm) | Quantity (PCS) | Approx. Gross Weight (KG) |
|-----------------------------|-------------------|----------------------------------|-------------------|-------------------------------|-------------------|---------------------------|
| 525 x 31 x 6 | 50 | 558 x 150 x 40 | 1,000 | 570 x 235 x 170 | 5,000 | 11.85 |

RECOMMENDED SCREW MOUNTING ARRANGEMENT

Recommended isolated mounting when screw is at heatsink potential. 4-40 hardware is used.

Screw should not be tightened with any type of air-forced torque or equipment that may cause high impact on device package. The insulating bushing inside the mounting hole will insure the screw threads do not contact the metal base.

The interface should apply a layer of thermal grease or a highly conductive thermal pad for better heat dissipation.

